

=> FIL REG

FILE 'REGISTRY' ENTERED AT 14:23:50 ON 01 APR 2009  
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FILE 'LCA' ENTERED AT 13:18:18 ON 01 APR 2009

L1 364 SEA (VALVE? OR METAL#### OR NIOBIUM? OR ALOY? OR  
AMALGAM? OR INGOT? OR BULLION?) (2A) (PENTOXIDE? OR  
OXIDE? OR DIOXIDE? OR SUBOXIDE? OR SUB (2A) OXIDE)  
L2 2 SEA GETTER? (2A) (MATERIAL? OR GAS## OR SUBSTANCE?)  
L3 2173 SEA HYDROGEN OR 1333-74-0 OR H2 OR NOBLE (2A) GAS  
L4 5586 SEA PARTICL? OR MICROPARTICL? OR PARTICULAT? OR DUST? OR  
GRIT? OR GRAIN# OR GRANUL? OR POWDER? OR SOOT? OR SMUT?  
OR FINES# OR PRILL? OR FLAKE# OR PELLET? OR BB#  
L5 13 SEA (OXYGEN? OR O2) (2A) REDUC?  
L6 0 SEA B213 OR B (A) 213  
L7 79 SEA ASTM#  
L8 182 SEA CAPACIT!R? OR CAPACITANC? OR CAPACIT!R (2A) ELECTRODE  
?  
L9 31 SEA (FLOW OR FLOWS OR FLOWED OR FLOWING#) (2A) (VALUE?  
OR PARAMETER? OR NUMBER? OR NUMERICAL? OR THRESHOLD? OR  
LIMIT?)  
L10 21 SEA (MILLIG? OR MG#) (W) (S OR SECOND# OR SEC#)  
L11 153 SEA (FLOW OR FLOWS OR FLOWED OR FLOWING#) (2A) (HIGH? OR  
INCREAS? OR ELEVAT? OR HEIGHTEN? OR RAIS? OR AUGMENT? OR  
LARGE? OR GREAT?)

FILE 'LREGISTRY' ENTERED AT 13:36:59 ON 01 APR 2009

L12 5 SEA (NB (L) O)/ELS (L) 2/ELC.SUB

FILE 'REGISTRY' ENTERED AT 13:38:21 ON 01 APR 2009

L13 279 SEA (NB (L) O)/ELS (L) 2/ELC.SUB  
E NIOBIUM/CN

L14 1 SEA NIOBIUM/CN

FILE 'LCA' ENTERED AT 13:43:17 ON 01 APR 2009

L15 8 SEA GETTERS/IT

L16 19 SEA GRANULATION/IT

FILE 'LREGISTRY' ENTERED AT 13:45:37 ON 01 APR 2009

L17 2 SEA (NB (L) H)/ELS (L) 2/ELC.SUB

FILE 'REGISTRY' ENTERED AT 13:46:49 ON 01 APR 2009

L18 159 SEA (NB (L) H)/ELS (L) 2/ELC.SUB

FILE 'STNGUIDE' ENTERED AT 13:47:35 ON 01 APR 2009  
L19           0 SEA GETTER?

FILE 'REGISTRY' ENTERED AT 13:51:07 ON 01 APR 2009  
L20           E NIOBIUM OXIDE/CN  
              2 SEA "NIOBIUM OXIDE"/CN

FILE 'HCA' ENTERED AT 13:52:44 ON 01 APR 2009  
L21        20098 SEA L13 OR L20  
L22        73115 SEA L14  
L23        681 SEA L18  
L24        21 SEA L19 AND L21  
L25        14 SEA L24 AND (VALV? OR L22 OR L23 OR L8 OR L4 OR L5 OR  
              L3)

FILE 'REGISTRY' ENTERED AT 14:01:57 ON 01 APR 2009  
L26           E HYDROGEN/CN  
              1 SEA HYDROGEN/CN

FILE 'HCA' ENTERED AT 14:02:13 ON 01 APR 2009  
L27        356645 SEA L26  
L28        7 SEA L24 AND L27

FILE 'HCA' ENTERED AT 14:04:05 ON 01 APR 2009  
L29        180 SEA L19 AND VALV?  
L30        2 SEA L29 AND L21  
L31        11 SEA L29 AND L22  
L32        1 SEA L29 AND L23  
L33        23 SEA L25 OR L28 OR L30 OR L32 OR L31  
L34        7 SEA L24 NOT L33  
L35        349 SEA L8 AND (L9 OR L10 OR L11)  
L36        74 SEA L8 AND L9  
L37        13 SEA L8 AND L10  
L38        269 SEA L8 AND L11  
L39        7 SEA L36 AND L38  
L40        0 SEA L8 AND L6  
L41        63 SEA L8 AND L7  
L42        0 SEA L41 AND (L9 OR L10 OR L11)  
L43        0 SEA L6 AND (L9 OR L10 OR L11)  
L44        203 SEA B213 OR B (A) 213  
L45        1 SEA L44 AND L7

FILE 'HCA' ENTERED AT 14:18:20 ON 01 APR 2009  
L46        0 SEA L41 AND L36  
L47        0 SEA L41 AND L38  
L48        0 SEA L21 AND L36  
L49        2 SEA L21 AND L38

L50            0 SEA L21 AND L41  
L51            23 SEA L37 OR L39 OR L45 OR L49  
L52            20 SEA 1808-2003/PY,PRY,AY AND L33  
L53            6 SEA 1808-2003/PY,PRY,AY AND L34  
L54            18 SEA 1808-2003/PY,PRY,AY AND L51

=> FIL HCA

FILE 'HCA' ENTERED AT 14:24:00 ON 01 APR 2009  
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(SEARCH OF REQUEST'S "ADDITIONAL COMMENTS")

=> D L54 1-18 BIB ABS HITRN HITIND RE

L54 ANSWER 1 OF 18 HCA COPYRIGHT 2009 ACS on STN  
AN 136:13484 HCA Full-text  
TI SiO<sub>2</sub> films deposited on silicon at low temperature by plasma-enhanced decomposition of hexamethyldisilazane: Defect characterization  
AU Croci, S.; Pecheur, A.; Autran, J. L.; Vedda, A.; Caccavale, F.; Martini, M.; Spinolo, G.  
CS Laboratoire de Physique de la Matiere, UMR CNRS 5511, Institut National des Sciences Appliquees de Lyon, Villeurbanne, F-69621, Fr.  
SO Journal of Vacuum Science & Technology, A: Vacuum, Surfaces, and Films (2001), 19(5), 2670-2675  
CODEN: JVTAD6; ISSN: 0734-2101  
PB American Institute of Physics  
DT Journal  
LA English  
AB Silicon dioxide films have been deposited by plasma-enhanced chem. vapor deposition at low substrate temp. (50°C) in a parallel-plate reactor using hexamethyldisilazane (HMDS), dild. in He, and O<sub>2</sub> as Si and O precursors. The effect of the O<sub>2</sub>/(HMDS+He) flow rate ratio on the oxide properties has been investigated in the range of 0.05-1.25 by means of deposition rate, wet etching rate, secondary ion mass spectrometry, thermally stimulated luminescence, and high frequency capacitance-voltage measurements. Both the deposition rate and the etching rate increase by increasing the O<sub>2</sub>/(HMDS+He) flow rate ratio and reach a const. value at flow rate ratios higher than 0.6. The strong increase and satn. in the deposition rate can be attributed to